

# MOS FIELD EFFECT TRANSISTOR 2SK3366

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK3366 is N-Channel MOS Field Effect Transistor designed for DC/DC converter application of notebook computers.

#### **FEATURES**

· Low on-resistance

 $R_{\text{DS(on)1}}$  = 21  $m\Omega$  (MAX.) (Vgs = 10 V, Ip = 10 A)

RDS(on)2 = 33  $m\Omega$  (MAX.) (VGs = 4.5 V, ID = 10 A)

 $R_{DS(on)3} = 43 \text{ m}\Omega \text{ (MAX.) (Vgs} = 4.0 \text{ V, ID} = 10 \text{ A)}$ 

• Low Ciss : Ciss = 730 pF (TYP.)

• Built-in gate protection diode

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE
2SK3366	TO-251
2SK3366-Z	TO-252

## ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (Vss = 0 V)	VDSS	30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC)	ID(DC)	±20	Α
Drain Current (Pulse) Note	D(pulse)	±80	Α
Total Power Dissipation (Tc = 25 °C)	Рт	30	W
Total Power Dissipation (TA = 25 °C)	Рт	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to + 150	°C

**Note** PW  $\leq$  10  $\mu$ s, Duty cycle  $\leq$  1 %

#### THERMAL RESISTANCE

Channel to case	Rth(ch-C)	4.17	°C/W
Channel to ambient	Rth(ch-A)	125	°C/W

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.



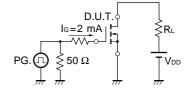
# **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 10 A		17.2	21	mΩ
	RDS(on)2	Vgs = 4.5 V, ID = 10 A		26	33	mΩ
	RDS(on)3	Vgs = 4.0 V, ID = 10 A		33	43	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A	5	10		S
Drain Leakage Current	loss	Vps = 30 V, Vgs = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		730		pF
Output Capacitance	Coss			250		pF
Reverse Transfer Capacitance	Crss			120		pF
Turn-on Delay Time	td(on)	$I_D = 10 \text{ A}, V_{GS(on)} = 10 \text{ V}, V_{DD} = 15 \text{ V},$		28		ns
Rise Time	tr	$R_G = 10 \Omega$		420		ns
Turn-off Delay Time	td(off)			47		ns
Fall Time	t <sub>f</sub>			64		ns
Total Gate Charge	Q <sub>G</sub>	ID = 20 A, VDD = 24 V, VGS = 10 V		15		nC
Gate to Source Charge	Qgs			2.8		nC
Gate to Drain Charge	Q <sub>GD</sub>			4.1		nC
Body Diode forward Voltage	V <sub>F(S-D)</sub>	IF = 20 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 20 A, VGS = 0 V		30		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		26		nC

#### **TEST CIRCUIT 1 SWITCHING TIME**

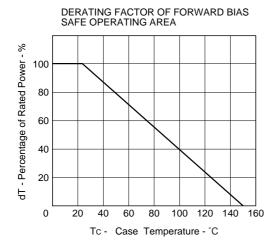
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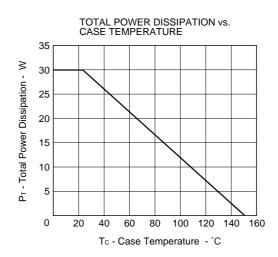
# **TEST CIRCUIT 2 GATE CHARGE**

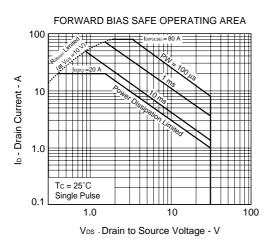


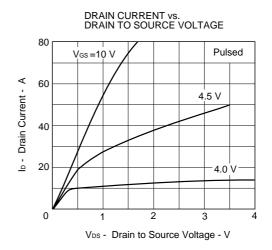


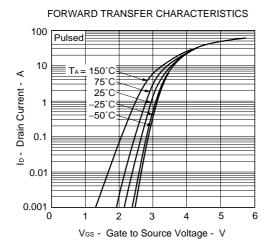
# TYPICAL CHARACTERISTICS (TA = 25 °C)





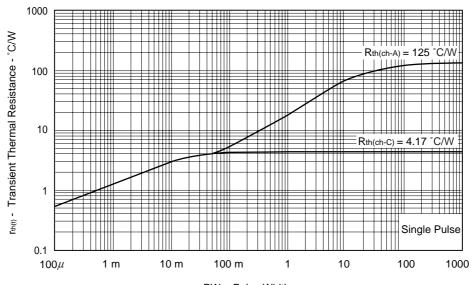






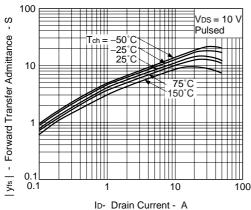
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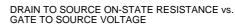
#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

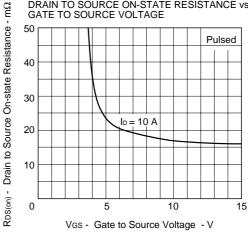


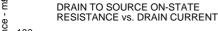
PW - Pulse Width - s

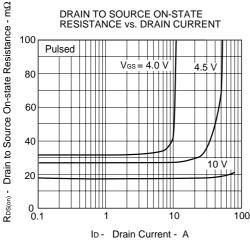


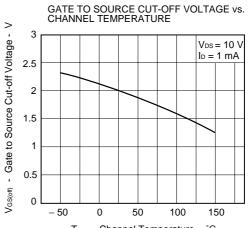






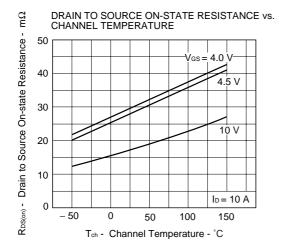


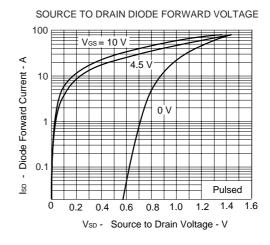


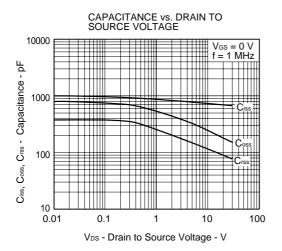


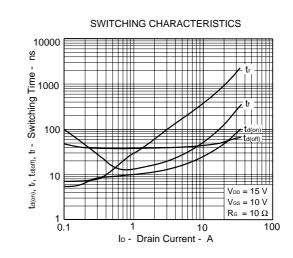
Tch - Channel Temperature - °C

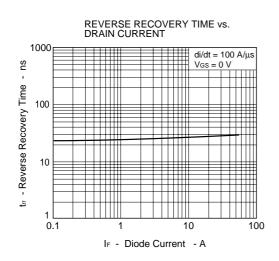


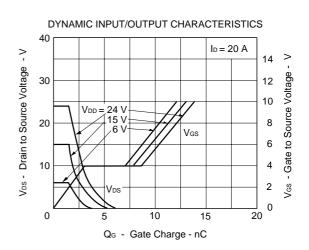








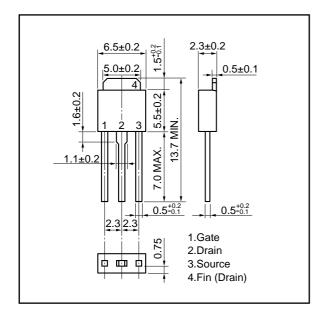




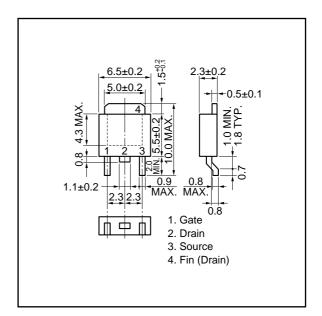


# PACKAGE DRAWINGS (Unit: mm)

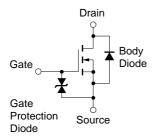
#### 1) TO-251 (MP-3)



## 2) TO-252 (MP-3Z)



#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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